SN74LVC2244A **OCTAL BUFFER/DRIVER** WITH 3-STATE OUTPUTS

SCAS572C - APRIL 1996 - REVISED JULY 1997

20 🛛 V_{CC}

19 20E

18 1Y1

17 1 2A4

16 1Y2

15 2A3

14 1Y3 13 2A2

12] 1Y4

11 🛛 2A1

DB, DW, OR PW PACKAGE (TOP VIEW)

1OE

1A1 2

2Y4 🛛 3

1A2 **1**4

2Y3 **5**

1A3 6

2Y2 7

1A4 🛛 8

2Y1 9

GND 🛛 10

- EPIC[™] (Enhanced-Performance Implanted **CMOS) Submicron Process**
- Output Ports Have Equivalent 26- Ω Series **Resistors, So No External Resistors Are** Required
- Typical VOLP (Output Ground Bounce) < 0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- Typical VOHV (Output VOH Undershoot) > 2 V at V_{CC} = 3.3 V, T_A = 25° C
- Power Off Disables Inputs/Outputs, Permitting Live Insertion
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V_{CC})
- ESD Protection Exceeds 2000 V Per • MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages

description

This octal buffer/line driver is designed for 2.7-V to 3.6-V V_{CC} operation.

The SN74LVC2244A is organized as two 4-bit line drivers with separate output-enable (\overline{OE}) inputs. When \overline{OE} is low, the device passes data from the A inputs to the Y outputs. When OE is high, the outputs are in the high-impedance state.

The outputs, which are designed to sink up to 12 mA, include equivalent 26-Ω resistors to reduce overshoot and undershoot.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

To ensure the high-impedance state during power up or power down, $\overline{\text{OE}}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74LVC2244A is characterized for operation from -40°C to 85°C.

FUNCTION TABLE (each buffer)							
	INP	UTS	OUTPUT				
	OE	Α	Y				
	L	Н	Н				
	L	L	L				
	Н	Х	Z				



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logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

Supply voltage range, V _{CC} Input voltage range, V _I (see Note 1)	
Voltage range applied to any output in the high-impedance or power-off state, V _O (see Note 1)	-0.5 V to 6.5 V
Voltage range applied to any output in the high or low state, V_{Ω}	
(see Notes 1 and 2)	$\dots -0.5$ V to V _{CC} + 0.5 V
Input clamp current, I _{IK} (V _I < 0)	
Output clamp current, I_{OK} (V _O < 0 or V _O > V _{CC})	±50 mA
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$ (see Note 2)	
Continuous current through V _{CC} or GND	
Package thermal impedance, θ_{JA} (see Note 3): DB package	
DW package	
PW package	
Storage temperature range, T _{stg}	

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. The value of V_{CC} is provided in the recommended operating conditions table.

3. The package thermal impedance is calculated in accordance with JESD 51.



recommended operating conditions (see Note 4)

			MIN	MAX	UNIT
Vee	Operatin	Operating	2	3.6	V
Vcc	Supply voltage	Data retention only	1.5		v
VIH	High-level input voltage	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2		V
VIL	Low-level input voltage	$V_{CC} = 2.7 V \text{ to } 3.6 V$		0.8	V
VI	Input voltage		0	5.5	V
٧ ₀	Output voltage	High or low state	0	VCC	V
		3 state	0	5.5	v
ЮН	High lovel output current $V_{CC} = 2.7 V$			-8	mA
	High-level output current	$V_{CC} = 3 V$		-12	ША
IOL	Low lovel output ourrept	$V_{CC} = 2.7 V$		8	mA
	Low-level output current V _{CC} = 3 V			12	ША
$\Delta t/\Delta v$	Input transition rise or fall rate		0	10	ns/V
TA	Operating free-air temperature		-40	85	°C

NOTE 4: Unused inputs must be held high or low to prevent them from floating.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST C	ONDITIONS	V _{CC}	MIN	TYP†	MAX	UNIT	
	I _{OH} = -100 μA		2.7 V to 3.6 V	V _{CC} -0.2			-	
	I _{OH} = -4 mA		2.7 V	2.2				
VOH	$I_{OH} = -6 \text{ mA}$		3 V	2.4			V	
	I _{OH} = -8 mA		2.7 V	2				
	I _{OH} = -12 mA		3 V	2				
	l _{OL} = 100 μA		2.7 V to 3.6 V			0.2	V	
	I _{OL} = 4 mA		2.7 V			0.4		
V _{OL}	I _{OL} = 6 mA	OL = 6 mA 3 V				0.55		
	I _{OL} = 8 mA		2.7 V			0.6		
	I _{OL} = 12 mA		3 V			0.8		
Ц	V ₁ = 0 to 5.5 V		3.6 V			±5	μA	
l _{off}	V _I or V _O = 5.5 V		0			±10	μA	
I _{OZ}	V _O = 0 to 5.5 V		3.6 V			±10	μA	
1	$V_{I} = V_{CC} \text{ or } GND$		2.6.14			10	۵	
lcc	$3.6 V \le V_1 \le 5.5 V^{\ddagger}$	IO = 0	3.6 V			10	μA	
ΔICC	One input at V _{CC} – 0.6 V,	Other inputs at V_{CC} or GND	2.7 V to 3.6 V			500	μA	
Ci	VI = V _{CC} or GND		3.3 V		4		pF	
Co	$V_{O} = V_{CC}$ or GND		3.3 V		5.5		pF	

[†] All typical values are at V_{CC} = 3.3 V, T_A = 25°C. [‡] This applies in the disabled state only.



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switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	то (оитрит)	V _{CC} = 3.3 V ± 0.3 V		V _{CC} = 2.7 V		UNIT
			MIN	MAX	MIN	MAX	
^t pd	А	Y	1.5	5.5		6.4	ns
ten	OE	Y	1	7.1		8.1	ns
^t dis	OE	Y	1.5	6.8		7.3	ns
t _{sk(o)} †				1.3			ns

[†] Skew between any two outputs of the same package switching in the same direction. This parameter is warranted but not production tested.

operating characteristics, V_{CC} = 3.3 V, T_A = 25°C

PARAMETER			TEST C	ONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance per buffer/driver	Outputs enabled	C _L = 0,	f = 10 MHz	46	pF
		Outputs disabled			2	





PARAMETER MEASUREMENT INFORMATION

- NOTES: A. CL includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control. C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_Q = 50 Ω , t_f \leq 2.5 ns, t_f \leq 2.5 ns.

 - D. The outputs are measured one at a time with one transition per measurement.
 - E. tPZL and tPZH are the same as ten.
 - F. tpLz and tpHz are the same as tdis.
 - G. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



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